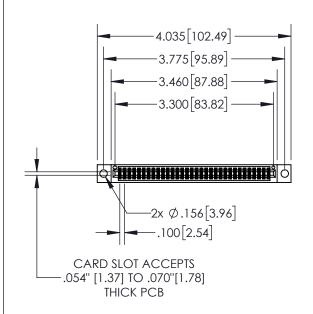
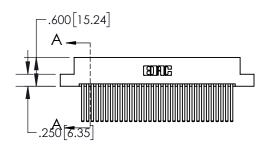
**Contact Dimensions:** 

544-Wire Wrap .050x.025(1.27x0.64) - Tail LG=.750(19.05) .100 (2.54) Contact Spacing x .200 (5.08) Row Spacing





- INSULATOR MATERIAL: THERMOPLASTIC, UL 94V-0
- CONTACT MATERIAL; COPPER TIN ALLOY CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING ON THE CONTACT TAILS, NICKEL UNDERPLATE



1

.330[8.38] CARD SLOT				
.370[9.40]				
SECTION A-A				
.160[4.06] POINT OF CONTACT				
200[5.08]				

845/893	SERIES HIGH TEMF	CARD EDG	SE CONNECTOR
PART N	JMBFR: 895-064-54	4-204	



ACAD REFERENCE NO. 845-ENG-MASTER DRAWN: R.STA.MONICA DATE:MAY.16/2017 1:2 SHEET 1 OF 2

845-ENG-MASTER







- INSULATOR MATERIAL: THERMOPLASTIC POLYESTER, UL 94V-0 DAP MATERIAL AVAILABLE UPON REQUEST
- CONTACT MATERIAL; COPPER ALLOY

CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING ON THE CONTACT TAILS, NICKEL UNDERPLATE

## 845/895 SERIES HIGH TEMP CARD EDGE CONNECTOR CONTACT CODE 555,556,558,559,560 DIMENSIONS

YOUR CONNECTION TO QUALITY & SERVICE

	ACAD REFERENCE NO. 845-ENG-MASTER			
	DRAWN: R.STA.MONICA	DATE:MAY.16/2017		
	CHECKED:	DATE:		
	SCALE: 1:1	SHEET 2 OF 2		
D	DRAWING NUMBER	ISSUE		

845-ENG-MASTER

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